



INTERNATIONAL
GEMOLOGICAL
INSTITUTE

ELECTRONIC COPY

LABORATORY GROWN DIAMOND REPORT

August 24, 2026

IGI Report Number

Description

Shape and Cutting Style

Measurements

GRADING RESULTS

Carat Weight

Color Grade

Clarity Grade

ADDITIONAL GRADING INFORMATION

Polish

Symmetry

Fluorescence

Inscription(s)

Comments: As Grown - No indication of post-growth treatment.
This Laboratory Grown Diamond was created by High Pressure High Temperature (HPHT) growth process.
Type II

LG825657686

Report verification at [igi.org](#)

PROPORTIONS

Medium To Thick (Faceted)

12.5%

44%

61%

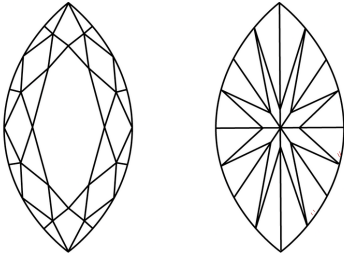
61.8%

Pointed



Sample Image Used

CLARITY CHARACTERISTICS



KEY TO SYMBOLS

Red symbols indicate internal characteristics.
Green symbols indicate external characteristics.

COLOR

D

E

F

G

H

I

J

Faint

Very Light

Light

CLARITY

FL

IF

VVS¹⁻²

VS¹⁻²

SI¹⁻²

I¹⁻³

Flawless

Internally Flawless

Very Very Slightly Included

Very Slightly Included

Slightly Included

Included

LABORATORY GROWN DIAMOND REPORT

August 24, 2026

IGI Report No LG825657686

MARQUISE BRILLIANT

10.08 X 5.24 X 3.24 MM

1.00 CARAT

D

VVS 1

61.8%

61%

Medium To Thick (Faceted)

Pointed

EXCELLENT

EXCELLENT

NONE

IGI LG825657686

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